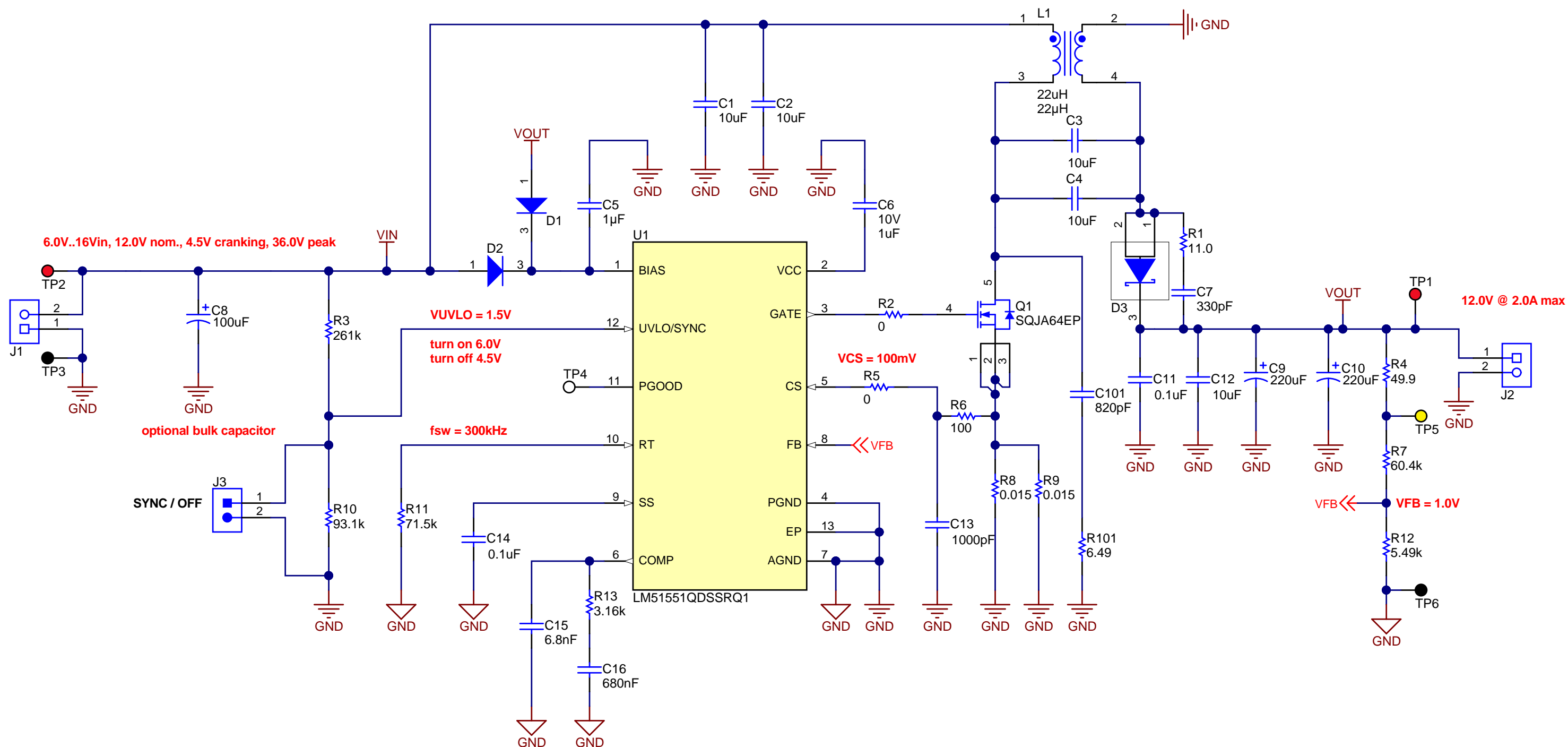


## Revision History

Revision	Notes
A	* first draft
B	* built & tested

**Design Notes:**

- R4 for test purpose only
- Designators >100 do not have a footprint on the PCB



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Number: <b>PMP30676</b>	Rev: <b>B</b>
SVN Rev: Not in version control	
Drawn By:	
Engineer: <b>M Zehendner</b>	

Designed for: <a href="#">Public Release</a>	Mod. Date: 4/29/2019
Project Title: <a href="#">Automotive SEPIC</a>	
Sheet Title: <a href="#">PMP30676_RevA</a>	
Assembly Variant: <a href="#">[No Variations]</a>	Sheet: <a href="#">1</a> of <a href="#">1</a>
File: <a href="#">PMP30676_RevB.SchDoc</a>	Size: A4
Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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